TELECOMMUNICATION SYSTEM SECONDARY PROTECTION

Ion-implanted Breakdown Region Precise and Stable Voltage Low Voltage Overshoot under Surge

DEVICE	V _{DRM}	V ₍₈₀₎
DETROL	V	٧
'3072F3	58	72
'3082F3	66	82

Planar Passivated Junctions Low Off-State Current < 10 μA

Rated for International Surge Wave Shapes

WAVE SHAPE	STANDARD	l _{79P}
2/10 µs	FCC Part 68	80
8/20 ha	ANSI C62.41	70
10/160 µs	FCC Part 68	60
10/560 µs	FCC Part 68	45
0.5/700 µs	RLM 88	38
	FTZ R12	50
10/700 µs	VDE 0433	50
	CCITT IX K17/K20	- 50
10/1000 µs	REA PE-60	35

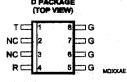
Surface Mount and Through-Hole Options

PACKAGE	PART # SUFFIX
Small-outline	D
Small-outline taped	DR
and rected	5 11
Plastic DIP	P
Single-in-line	SL

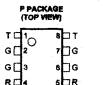
UL Recognized, E132482

description

These low voltage dual symmetrical transient voltage suppressor devices are designed to protect ISDN applications against transients caused by lightning strikes and a.c. power lines. Offered in two voltage variants to meet battery and protection requirements they are guaranteed to suppress and withstand the listed international lightning surges in both polarities. Transients are initially clipped by breakdown clamping until the voltage rises to the breakover level, which causes the device to crowbar. The high crowbar holding current prevents d.c. latchup as the current subsides.

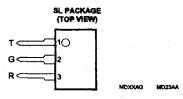


NC - No internal connection

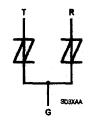


MOXXAF

Specified T terminal ratings require connection of pins 1 and 8. Specified R terminal ratings require connection of pins 4 and 5.



device symbol



Terminals T, R and G correspond to the atternetive line designators of A, B and C

These monolithic protection devices are fabricated in ion-implanted planar structures to ensure precise and matched breakover control and are virtually transparent to the system in normal operation

TISP3072F3, TISP3082F3 DUAL SYMMETRICAL TRANSIENT VOLTAGE SUPPRESSORS

MARCH 1994 - REVISED SEPTEMBER 1997

description (Continued)

The small-outline 8-pin assignment has been carefully chosen for the TISP series to maximise the inter-pin clearance and creepage distances which are used by standards (e.g. IEC950) to establish voltage withstand ratings.

absolute maximum ratings

RATING Repetitive peak off-state voltage (0°C < T₁ < 70°C) '3072F3 '3082F3 '3082F3			VALUE	UNIT
			± 58 ± 66	V
Non-repetitive peak on-state pulse current (see Notes 1, 2 and 3)				
1/2 µs (Gas tube differential transient, open-circuit voltage wa	ve shape 1/2 μs)		120	
2/10 µs (FCC Part 68, open-circuit voltage wave shape 2/10 µ	is)		80	
8/20 us (ANSI C62.41, open-circuit voltage wave shape 1.2/5	0 μs)		70	
10/160 µs. (FCC Part 68, open-circuit voltage wave shape 10/	160 µs)		60	
5/200 µs (VDE 0433, open-circuit voltage wave shape 2 kV, 10/700 µs)			50	Α
0.5/310 µs (RLM 88, open-circuit voltage wave shape 1.5 kV, 0.5/700 µs)			38	
5/310 µs (CCITT IX K17/K20, open-drouit voltage wave shape	e 2 kV, 10/700 µs)		50	
5/310 µs (FTZ R12, open-circuit voltage wave shape 2 kV, 10/	700 μs)		50	
10/560 µs (FCC Part 68, open-circuit voltage wave shape 10/	560 µs)		45	
10/1000 µs (REA PE-60, open-circuit voltage wave shape 10/	1000 µs)		35	
Non-repetitive peak on-state current (see Notes 2 and 3)	D Package		4	
50 Hz, 1 s	P Package	ITSM	6	Amns
	St. Package		6	
Initial rate of rise of on-state current, Linear current ramp, Maximum ramp value < 38 A			250	A/us
Junction temperature		Tj	40 to +150	°C
Storage temperature range		T _{stg}	-40 to +150	°C

- NOTES: 1. Further details on surge wave shapes are contained in the Applications Information section.
 - Initially the TISP must be in thermal equilibrium with 0°C < T_J <70°C. The surge may be repeated after the TISP returns to its initial
 conditions.
 - 3. Above 70°C, derate linearly to zero at 150°C lead temperature.

electrical characteristics for the T and R terminals, $T_J = 25$ °C

	PARAMETER TEST CONDITIONS			TISP:	072F3	TISPS	082F3	UNIT
	PANAMETEN	TEST CONDITIONS		MIN	MAX	MIN	MAX	O1461
IDRM	Repetitive peak off- state current	V _D = ±2V _{DRM} , 0°C < T _J < 70°C			±10		±10	μΑ
I _O	Off-state current	V _D = ±50 V			±10		±10	μA
		$f = 100 \text{ kHz}, V_d = 100 \text{ mV} V_D = 0,$	D Package	50†	150	50†	150	
Coff	Off-state capacitance	Third terminal voltage = -50 V to +50 V (see Notes 4 and 5)	P Package SL Package	65† 30†	200 100	65† 30†	100	i fF

NOTES: 4. These capacitance measurements employ a three terminal capacitance bridge incorporating a guard circuit. The third terminal is connected to the guard terminal of the bridge.

electrical characteristics for the T and G or the R and G terminals, T_J = 25°C

1		PARAMETER	TEST CONDITIONS		072F3	TISPS	082F3	UNIT	١
		PANAMETER	TEST CONDITIONS	MIN	MAX	MIN	MAX	01111	l
	DRM	Repetitive peak off- state current	$V_D = \pm V_{DRM}, 0^{\circ}C < T_J < 70^{\circ}C$		±10		±10	Ац	



^{5.} Further details on capacitance are given in the Applications Information section.

[†] Typical value of the parameter, not a limit value.

electrical characteristics for the T and G or the R and G terminals, T_J = 25°C (Continued)

	DADAMETED	AMETER TEST CONDITIONS		TISP3072F3		TISP3082F3		UNIT
	PARAMETER			MIN	MAX	MIN	MAX	UNI
V ₍₈₀₎	Breakover voltage	dv/dt = ±250 V/ms, Source Resistance = 300 Ω			±72		±82	
V _(BO)	Impulse breakover volt- age	dv/dt = ±1000 V/μs, di/dt < 20 A/μs Source Resistance = 50 Ω			±86†		±96†	٧
I _(BO)	Breakover current	dv/dt = ±250 V/ms, Source Resistance = 300 Ω		±0.15	±0.6	±0.15	±0.6	Α
V†	On-state voltage	I _T = ±5 A, t _W = 100 μs			±3		±3	v
l _H	Holding current	dl/dt = -/+30 mA/ms		±0.15		±0.15		A
dv/dt	Critical rate of rise of off-state voltage	Linear voltage ramp, Maximum ramp value < 0.85V _{(BR)MIN}		±5		±5		kV/µs
10	Off-state current	V _D = ±50 V			±10		±10	μA
		1 = 100 kHz, V _d = 100 mV	V _D ≈ 0,	82†	140	82†	140	ρF
Coff	Off-state capacitance	Third terminal voltage ≈ -50 V to +50 V	V _D ≈ -5 V	49†	85	49†	85	p₹
		(see Notes 6 and 7)	V _D ≈ -50 V	25†	40	25†	40	pF

NOTES: 6 These capacitance measurements employ a three terminal capacitance bridge incorporating a guard circuit. The third terminal is connected to the guard terminal of the bridge.

7. Further details on capacitance are given in the Applications Information section.

PARAMETER MEASUREMENT INFORMATION

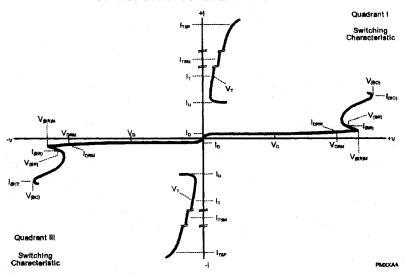


Figure 1. VOLTAGE-CURRENT CHARACTERISTIC FOR ANY PAIR OF TERMINALS

TISP3072F3, TISP3082F3 DUAL SYMMETRICAL TRANSIENT VOLTAGE SUPPRESSORS

MARCH 1984 - REVISED SEPTEMBER 1997

thermal characteristics

PARAMETER			TYP	MAX	UNIT
	D Package			160	
Raia Junction to free air thermal resistance	P Package			100	°C/W
	St. Package			105	

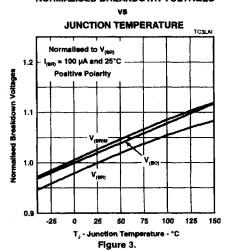
TYPICAL CHARACTERISTICS T and G, or R and G terminals

OFF-STATE CURRENT

JUNCTION TEMPERATURE 100 100 100 100 V₀ = 50 V 0-01 -25 0 25 50 75 100 126 150 T₁ - Junction Temperature - °C

Figure 2.

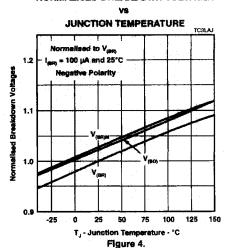
NORMALISED BREAKDOWN VOLTAGES



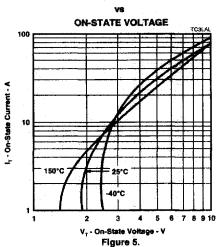
[†] Typical value of the parameter, not a limit value.

TYPICAL CHARACTERISTICS T and G, or R and G terminals

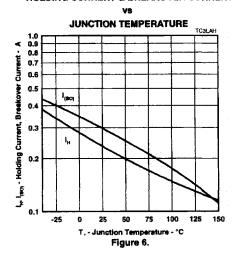
NORMALISED BREAKDOWN VOLTAGES



ON-STATE CURRENT



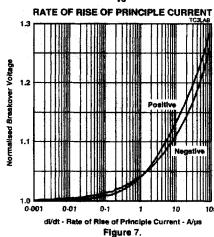
HOLDING CURRENT & BREAKOVER CURRENT



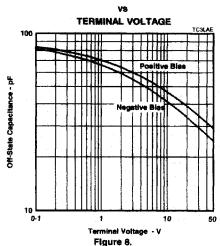


TYPICAL CHARACTERISTICS T and G, or R and G terminals

NORMALISED BREAKOVER VOLTAGE



OFF-STATE CAPACITANCE

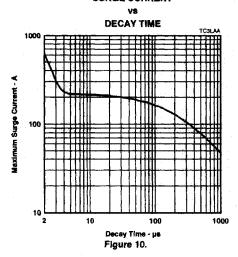


OFF-STATE CAPACITANCE

JUNCTION TEMPERATURE 500 Off-State Capacitance - pF 100 Terminal Bias = 0 Terminal Biss = 50 V -25 75 100

T_J - Junction Temperature - °C Figure 9.

TYPICAL CHARACTERISTICS T and G, or R and G terminals SURGE CURRENT

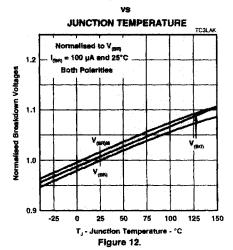


TYPICAL CHARACTERISTICS T and R terminals

OFF-STATE CURRENT

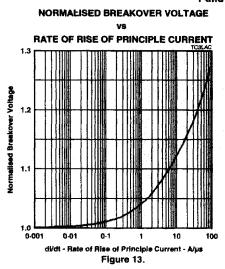
Figure 11.

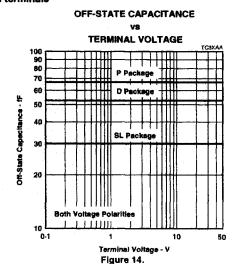
NORMALISED BREAKDOWN VOLTAGES





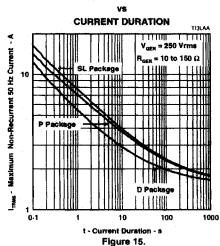
TYPICAL CHARACTERISTICS T and R terminals

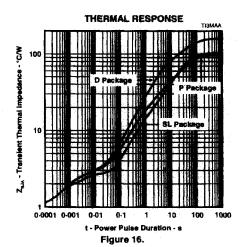




THERMAL INFORMATION

MAXIMUM NON-RECURRING 50 Hz CURRENT





APPLICATIONS INFORMATION

electrical characteristics

The electrical characteristics of a TISP are strongly dependent on junction temperature, T_J . Hence a characteristic value will depend on the junction temperature at the instant of measurement. The values given in this data sheet were measured on commercial testers, which generally minimise the temperature rise caused by testing. Application values may be calculated from the parameters' temperature curves, the power dissipated and the thermal response curve (Z_A).

lightning surge

wave shape notation

Most lightning tests, used for equipment verification, specify a unidirectional sawtooth waveform which has an exponential rise and an exponential decay. Wave shapes are classified in terms of peak amplitude (voltage or current), rise time and a decay time to 50% of the maximum amplitude. The notation used for the wave shape is amplitude, rise time/decay time. A 50A, 5/310 µs wave shape would have a peak current value of 50 A, a rise time of 5 µs and a decay time of 310 µs. The TISP surge current graph comprehends the wave shapes of commonly used surges.

generators

There are three categories of surge generator type, single wave shape, combination wave shape and circuit defined. Single wave shape generators have essentially the same wave shape for the open circuit voltage and short circuit current (e.g. 10/1000 µs open circuit voltage and short circuit current). Combination generators have two wave shapes, one for the open circuit voltage and the other for the short circuit current (e.g. 1.2/50 µs open circuit voltage and 8/20 µs short circuit current). Circuit specified generators usually equate to a combination generator, although typically only the open circuit voltage waveshape is referenced (e.g. a 10/700 µs open circuit voltage generator typically produces a 5/310 µs short circuit current). If the combination or circuit defined generators operate into a finite resistance the wave shape produced is intermediate between the open circuit and short circuit values.

current rating

When the TISP switches into the on-state it has a very low impedance. As a result, although the surge wave shape may be defined in terms of open circuit voltage, it is the current wave shape that must be used to assess the required TISP surge capability. As an example, the CCITT IX K17 1.5 kV, 10/700 µs surge is changed to a 38 A, 5/310 µs waveshape when driving into a short circuit. Thus the TISP surge current capability, when directly connected to the generator, will be found for the CCITT IX K17 waveform at 310 µs on the surge graph and not 700 µs. Some common short circuit equivalents are tabulated below:

STANDARD	OPEN CIRCUIT VOLTAGE	SHORT CIRCUIT CURRENT
CCITT IX K17	1.5 kV, 10/700 us	38 A, 5/310 µs
CCITT IX K20	1 kV, 10/700 us	25 A, 5/310 µs
RLM88	1.5 kV, 0.5/700 µs	38 A, 0.2/310 µs
VDE 0433	2.0 kV 10/700 us	50 A, 5/200 us
FTZ R12	2.0 kV, 10/700 us	50 A. 5/310 us

Any series resistance in the protected equipment will reduce the peak circuit current to less than the generators' short circuit value. A 2 kV open circuit voltage, 50 A short circuit current generator has an effective output impedance of 40 Ω (2000/50). If the equipment has a series resistance of 25 Ω then the surge current requirement of the TISP becomes 31 A (2000/65) and not 50 A.



APPLICATIONS INFORMATION

protection voltage

The protection voltage, $(V_{(BO)})$, increases under lightning surge conditions due to thyristor regeneration. This increase is dependent on the rate of current rise, dl/dt, when the TISP is clamping the voltage in its breakdown region. The $V_{(BO)}$ value under surge conditions can be estimated by multiplying the 50 Hz rate $V_{(BO)}$ (250 V/ms) value by the normalised increase at the surge's dl/dt (Figure 6.) . An estimate of the di/dt can be made from the surge generator voltage rate of rise, dv/dt, and the circuit resistance.

As an example, the CCITT IX K17 1.5 kV, 10/700 μ s surge has an average dv/dt of 150 V/ μ s, but, as the rise is exponential, the initial dv/dt is higher, being in the region of 450 V/ μ s. The instantaneous generator output resistance is 25 Ω . If the equipment has an additional series resistance of 20 Ω , the total series resistance becomes 45 Ω . The maximum di/dt then can be estimated as 450/45 = 10 A/ μ s. In practice the measured di/dt and protection voltage increase will be lower due to inductive effects and the finite slope resistance of the TISP breakdown region.

capacitance

off-state capacitance

The off-state capacitance of a TISP is sensitive to junction temperature, $T_{\rm J}$, and the bias voltage, comprising of the dc voltage, $V_{\rm D}$, and the ac voltage, $V_{\rm d}$. All the capacitance values in this data sheet are measured with an ac voltage of 100 mV. The typical 25°C variation of capacitance value with ac bias is shown in Figure 17 When $V_{\rm D}>>V_{\rm d}$ the capacitance value is independent on the value of $V_{\rm d}$. The capacitance is essentially constant over the range of normal telecommunication frequencies.

NORMALISED CAPACITANCE

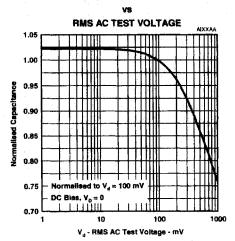


Figure 17.

APPLICATIONS INFORMATION

longitudinal balance

Figure 18 shows a three terminal TISP with its equivalent "delta" capacitance. Each capacitance, C_{TG} , C_{RG} and C_{TR} , is the true terminal pair capacitance measured with a three terminal or guarded capacitance bridge. If wire R is biased at a larger potential than wire T then $C_{TG} \sim C_{RG}$. Capacitance C_{TG} is equivalent to a capacitance of C_{RG} in parallel with the capacitive difference of $C_{TG} \sim C_{RG}$). The line capacitive unbalance is due to $C_{TG} \sim C_{RG}$) and the capacitance shunting the line is $C_{TR} + C_{RG}/2$.

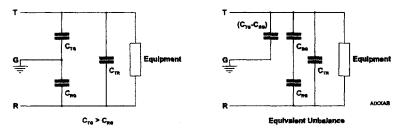


Figure 18.

All capacitance measurements in this data sheet are three terminal guarded to allow the designer to accurately assess capacitive unbalance effects. Simple two terminal capacitance meters (unguarded third terminal) give false readings as the shunt capacitance via the third terminal is included.